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## 8-/10-/12-Bit Voltage Output Digital-to-Analog Converter with EEPROM and I<sup>2</sup>C™ Interface

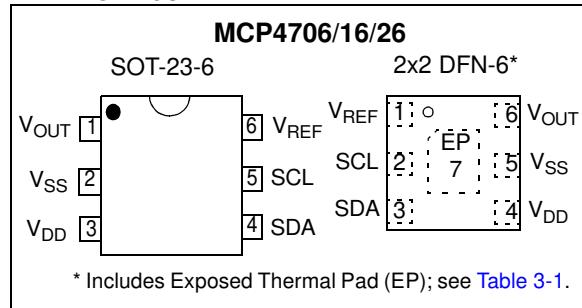
### Features:

- Output Voltage Resolutions:
  - 12-bit: **MCP4726**
  - 10-bit: **MCP4716**
  - 8-bit: **MCP4706**
- Rail-to-Rail Output
- Fast Settling Time of 6 µs (typical)
- DAC Voltage Reference Options:
  - V<sub>DD</sub>
  - V<sub>REF</sub> Pin
- Output Gain Options:
  - Unity (1x)
  - 2x, only when V<sub>REF</sub> pin is used as voltage source
- Nonvolatile Memory (EEPROM):
  - Auto Recall of Saved DAC register setting
  - Auto Recall of Saved Device Configuration (Voltage Reference, Gain, Power-Down)
- Power-Down modes:
  - Disconnects output buffer
  - Selection of V<sub>OUT</sub> pull-down resistors (640 kΩ, 125 kΩ, or 1 kΩ)
- Low-Power Consumption:
  - Normal Operation: 210 µA typical
  - Power-Down Operation: 60 nA typical (PD1:PD0 = 11)
- Single-Supply Operation: 2.7V to 5.5V
- I<sup>2</sup>C™ Interface:
  - Eight Available Addresses
  - Standard (100 kbps), Fast (400 kbps), and High-Speed (3.4 Mbps) modes
- Small 6-lead SOT-23 and DFN (2x2) Packages
- Extended Temperature Range: -40°C to +125°C

### Applications:

- Set Point or Offset Trimming
- Sensor Calibration
- Low-Power Portable Instrumentation
- PC Peripherals
- Data Acquisition Systems
- Motor Control

### Package Types



### Description:

The MCP4706/4716/4726 are single channel 8-bit, 10-bit, and 12-bit buffered voltage output Digital-to-Analog Converters (DAC) with nonvolatile memory and an I<sup>2</sup>C serial interface. This family will also be referred to as MCP47X6.

The V<sub>REF</sub> pin or the device V<sub>DD</sub> can be selected as the DAC's reference voltage. When V<sub>DD</sub> is selected, V<sub>DD</sub> is connected internally to the DAC reference circuit. When the V<sub>REF</sub> pin is used, the user can select the output buffer's gain to 1 or 2. When the gain is 2, the V<sub>REF</sub> pin voltage should be limited to a maximum of V<sub>DD</sub>/2.

The DAC register value and Configuration bits can be programmed to nonvolatile memory (EEPROM). The nonvolatile memory holds the DAC register and Configuration bit values when the device is powered off. A device Reset (such as a Power-on Reset) latches these stored values into the volatile memory.

Power-Down modes enable system current reduction when the DAC output voltage is not required. The V<sub>OUT</sub> pin can be configured to present a low, medium, or high resistance load.

These devices have a two-wire I<sup>2</sup>C™ compatible serial interface for standard (100 kHz), fast (400 kHz), or High-Speed (3.4 MHz) mode.

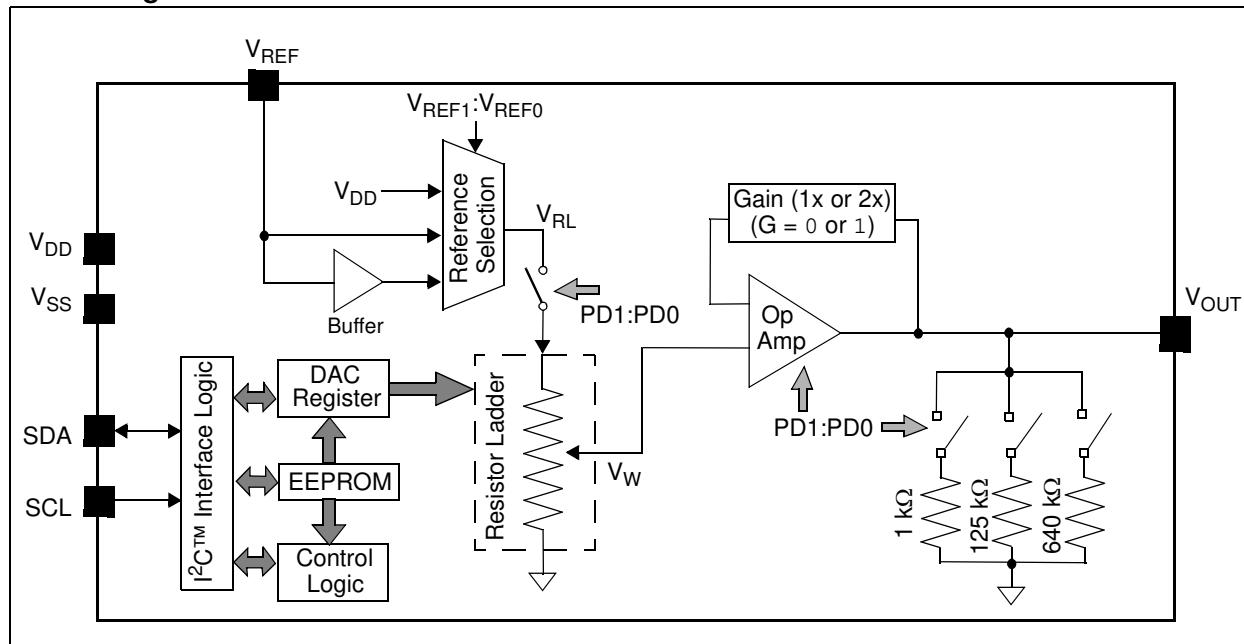
These devices are available in small 6-pin SOT-23 and DFN 2x2 mm packages.

# MCP4706/4716/4726

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## Block Diagram



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

Voltage on V <sub>DD</sub> with respect to V <sub>SS</sub> .....	-0.6V to +6.5V
Voltage on all pins with respect to V <sub>SS</sub> .....	-0.3V to V <sub>DD</sub> + 0.3V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0, V <sub>I</sub> > V <sub>DD</sub> ) .....	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>DD</sub> ) .....	±20 mA
Maximum input current source/sunk by SDA, SCL pins .....	2 mA
Maximum output current sunk by SDA Output pin .....	25 mA
Maximum current out of V <sub>SS</sub> pin .....	50 mA
Maximum current into V <sub>DD</sub> pin .....	50 mA
Maximum current sourced by the V <sub>OUT</sub> pin .....	40 mA
Maximum current sunk by the V <sub>OUT</sub> pin .....	40 mA
Maximum current sunk by the V <sub>REF</sub> pin .....	40 µA
Package power dissipation (T <sub>A</sub> = +50°C, T <sub>J</sub> = +150°C)	
SOT-23-6.....	452 mW
DFN-6.....	1098 mW
Storage temperature .....	-65°C to +150°C
Ambient temperature with power applied .....	-55°C to +125°C
ESD protection on all pins.....	≥ 6 kV (HBM) ≥ 400V (MM)
Maximum Junction Temperature (T <sub>J</sub> ) .....	+150°C

**† Notice:** Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

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## ELECTRICAL CHARACTERISTICS

**Electrical Specifications:** Unless otherwise indicated,  $V_{DD} = 2.7V$  to  $5.5V$ ,  $V_{SS} = 0V$ ,  $R_L = 5\text{ k}\Omega$  from  $V_{OUT}$  to GND,  $C_L = 100\text{ pF}$ ,  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ . Typical values at  $+25^\circ\text{C}$ .

Parameters	Symbol	Min	Typical	Max	Units	Conditions
<b>Power Requirements</b>						
Input Voltage	$V_{DD}$	2.7	—	5.5	V	
Input Current	$I_{DD}$	—	210	400	$\mu\text{A}$	$V_{REF1}:V_{REF0} = 00$ , $SCL = SDA = V_{SS}$ , $V_{OUT}$ is unloaded, volatile DAC Register = 0x000
		—	210	400	$\mu\text{A}$	$V_{REF1}:V_{REF0} = 11$ , $V_{REF} = V_{DD}$ , $SCL = SDA = V_{SS}$ , $V_{OUT}$ is unloaded, volatile DAC Register = 0x000
Power-Down Current	$I_{DDP}$	—	0.09	2	$\mu\text{A}$	PD1:PD0 = 01 ( <b>Note 6</b> ), $V_{OUT}$ not connected
Power-On Reset Threshold	$V_{POR}$	—	2.2	—	V	RAM retention voltage, ( $V_{RAM}$ ) < $V_{POR}$
Power-Up Ramp Rate	$V_{RAMP}$	1	—	—	V/S	( <b>Note 1</b> , <b>Note 4</b> )
<b>DC Accuracy</b>						
Offset Error	$V_{OS}$		$\pm 0.02$	0.75	% of FSR	Code = 0x000h $V_{REF1}:V_{REF0} = 00$ , $G = 0$
Offset Error Temperature Coefficient	$V_{OS}/^\circ\text{C}$	—	$\pm 1$	—	ppm/ $^\circ\text{C}$	-40 $^\circ\text{C}$ to +25 $^\circ\text{C}$
		—	$\pm 2$	—	ppm/ $^\circ\text{C}$	+25 $^\circ\text{C}$ to +85 $^\circ\text{C}$
Zero-Scale Error	$E_{ZS}$	—	0.13	2.0	Lsb	<b>MCP4706</b> , Code = 0x00h
		—	0.52	7.7	Lsb	<b>MCP4716</b> , Code = 0x000h
		—	2.05	30.8	Lsb	<b>MCP4726</b> , Code = 0x000h
Full-Scale Error	$E_{FS}$	—	0.3	5.2	Lsb	<b>MCP4706</b> , Code = 0xFFh
		—	1.1	20.5	Lsb	<b>MCP4716</b> , Code = 0x3FFh
		—	4.1	82.0	Lsb	<b>MCP4726</b> , Code = 0xFFFFh
Gain Error ( <b>Note 2</b> )	$g_E$	-2	-0.10	2	% of FSR	<b>MCP4706</b> , Code = 0xFFh $V_{REF1}:V_{REF0} = 00$ , $G = 0$
		-2	-0.10	2	% of FSR	<b>MCP4716</b> , Code = 0x3FFh $V_{REF1}:V_{REF0} = 00$ , $G = 0$
		-2	-0.10	2	% of FSR	<b>MCP4726</b> , Code = 0xFFFFh $V_{REF1}:V_{REF0} = 00$ , $G = 0$
Gain Error Drift	$\Delta g/^\circ\text{C}$	—	-3	—	ppm/ $^\circ\text{C}$	
Resolution	n	8		bits		<b>MCP4706</b>
		10		bits		<b>MCP4716</b>
		12		bits		<b>MCP4726</b>
INL Error ( <b>Note 7</b> )	INL	-0.907	$\pm 0.125$	+0.907	Lsb	<b>MCP4706</b> (codes: 6 to 250)
		-3.625	$\pm 0.5$	+3.625	Lsb	<b>MCP4716</b> (codes: 25 to 1000)
		-14.5	$\pm 2$	+14.5	Lsb	<b>MCP4726</b> (codes: 100 to 4000)
DNL Error ( <b>Note 7</b> )	DNL	-0.05	$\pm 0.0125$	+0.05	Lsb	<b>MCP4706</b> (codes: 6 to 250)
		-0.188	$\pm 0.05$	+0.188	Lsb	<b>MCP4716</b> (codes: 25 to 1000)
		-0.75	$\pm 0.2$	+0.75	Lsb	<b>MCP4726</b> (codes: 100 to 4000)

**Note 1:** This parameter is ensured by design and is not 100% tested.

**2:** This Gain error does not include Offset error. See [Section 1.0 “Electrical Characteristics”](#) for more details in plots.

**3:** Within 1/2 Lsb of final value when code changes from 1/4 to 3/4 of FSR. (Example: 400h to C00h in 12-bit device).

**4:** The power-up ramp rate affects on uploading the EEPROM contents to the DAC register. It measures the rise of  $V_{DD}$  over time.

**5:** This parameter is ensured by characterization, and not 100% tested.

**6:** The PD1:PD0 = 10, and ‘11’ configurations should have the same current.

**7:**  $V_{DD} = V_{REF} = 5.5\text{V}$ .

## ELECTRICAL CHARACTERISTICS (CONTINUED)

**Electrical Specifications:** Unless otherwise indicated,  $V_{DD} = 2.7V$  to  $5.5V$ ,  $V_{SS} = 0V$ ,  $R_L = 5\text{ k}\Omega$  from  $V_{OUT}$  to GND,  $C_L = 100\text{ pF}$ ,  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ . Typical values at  $+25^\circ\text{C}$ .

Parameters	Symbol	Min	Typical	Max	Units	Conditions
<b>Output Amplifier</b>						
Minimum Output Voltage	$V_{OUT(MIN)}$	—	0.01	—	V	Output Amplifier's minimum drive
Maximum Output Voltage	$V_{OUT(MAX)}$	—	$V_{DD} - 0.04$	—	V	Output Amplifier's maximum drive
Phase Margin	PM	—	66	—	Degree ( $^\circ$ )	$C_L = 400\text{ pF}$ , $R_L = \infty$
Slew Rate	SR	—	0.55	—	V/ $\mu$ s	
Short Circuit Current	$I_{SC}$	7	15	24	mA	
Settling Time	$t_{SETTLING}$	—	6	—	$\mu$ s	<b>Note 3</b>
Power-Down Output Disable Time Delay	$T_{PDD}$	—	1	—	$\mu$ s	PD1:PD0 = 00 $\rightarrow$ 11, '10', or '01' started from falling edge SCL at end of ACK bit. $V_{OUT} = V_{OUT} - 10\text{ mV}$ . $V_{OUT}$ not connected.
Power-Down Output Enable Time Delay	$T_{PDE}$	—	10.5	—	$\mu$ s	PD1:PD0 = 11, '10', or '01' $\rightarrow$ "00" started from falling edge SCL at end of ACK bit. Volatile DAC Register = FFh, $V_{OUT} = 10\text{ mV}$ . $V_{OUT}$ not connected.
<b>External Reference (<math>V_{REF}</math>) (Note 1)</b>						
Input Range	$V_{REF}$	0.04	—	$V_{DD} - 0.04$	V	Buffered mode
		0	—	$V_{DD}$	V	Unbuffered mode
Input Impedance	$R_{VREF}$	—	210	—	k $\Omega$	Unbuffered mode
Input Capacitance	$C_{REF}$	—	29	—	pF	Unbuffered mode
-3 dB Bandwidth		—	86.5	—	kHz	$V_{REF} = 2.048V \pm 0.1V$ , $V_{REF1}:V_{REF0} = 10$ , G = 0
		—	67.7	—	kHz	$V_{REF} = 2.048V \pm 0.1V$ , $V_{REF1}:V_{REF0} = 10$ , G = 1
Total Harmonic Distortion	THD	—	-73	—	dB	$V_{REF} = 2.048V \pm 0.1V$ , $V_{REF1}:V_{REF0} = 10$ , G = 0, Frequency = 1 kHz
<b>Dynamic Performance (Note 1)</b>						
Major Code Transition Glitch		—	45	—	nV-s	1 LSb change around major carry (800h to 7FFh)
Digital Feedthrough		—	<10	—	nV-s	

**Note 1:** This parameter is ensured by design and is not 100% tested.

**2:** This Gain error does not include Offset error. See **Section 1.0 “Electrical Characteristics”** for more details in plots.

**3:** Within 1/2 LSb of final value when code changes from 1/4 to 3/4 of FSR. (Example: 400h to C00h in 12-bit device).

**4:** The power-up ramp rate affects on uploading the EEPROM contents to the DAC register. It measures the rise of  $V_{DD}$  over time.

**5:** This parameter is ensured by characterization, and not 100% tested.

**6:** The PD1:PD0 = 10, and '11' configurations should have the same current.

**7:**  $V_{DD} = V_{REF} = 5.5V$ .

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## ELECTRICAL CHARACTERISTICS (CONTINUED)

**Electrical Specifications:** Unless otherwise indicated,  $V_{DD} = 2.7V$  to  $5.5V$ ,  $V_{SS} = 0V$ ,  $R_L = 5 k\Omega$  from  $V_{OUT}$  to GND,  $C_L = 100 pF$ ,  $T_A = -40^\circ C$  to  $+125^\circ C$ . Typical values at  $+25^\circ C$ .

Parameters	Symbol	Min	Typical	Max	Units	Conditions
<b>Digital Interface</b>						
Output Low Voltage	$V_{OL}$	—	—	0.4	V	$I_{OL} = 3 \text{ mA}$
Input High Voltage (SDA and SCL Pins)	$V_{IH}$	$0.7V_{DD}$	—	—	V	
Input Low Voltage (SDA and SCL Pins)	$V_{IL}$	—	—	$0.3V_{DD}$	V	
Input Leakage	$I_{LI}$	—	—	$\pm 1$	$\mu\text{A}$	SCL = SDA = $V_{SS}$ or SCL = SDA = $V_{DD}$
Pin Capacitance	$C_{PIN}$	—	—	3	pF	(Note 5)
<b>EEPROM</b>						
EEPROM Write Time	$T_{WRITE}$	—	25	50	ms	
Data Retention		—	200	—	Years	At $+25^\circ C$ , (Note 1)
Endurance		1	—	—	Million Cycles	At $+25^\circ C$ , (Note 1)

**Note 1:** This parameter is ensured by design and is not 100% tested.

**2:** This Gain error does not include Offset error. See [Section 1.0 “Electrical Characteristics”](#) for more details in plots.

**3:** Within 1/2 LSb of final value when code changes from 1/4 to 3/4 of FSR. (Example: 400h to C00h in 12-bit device).

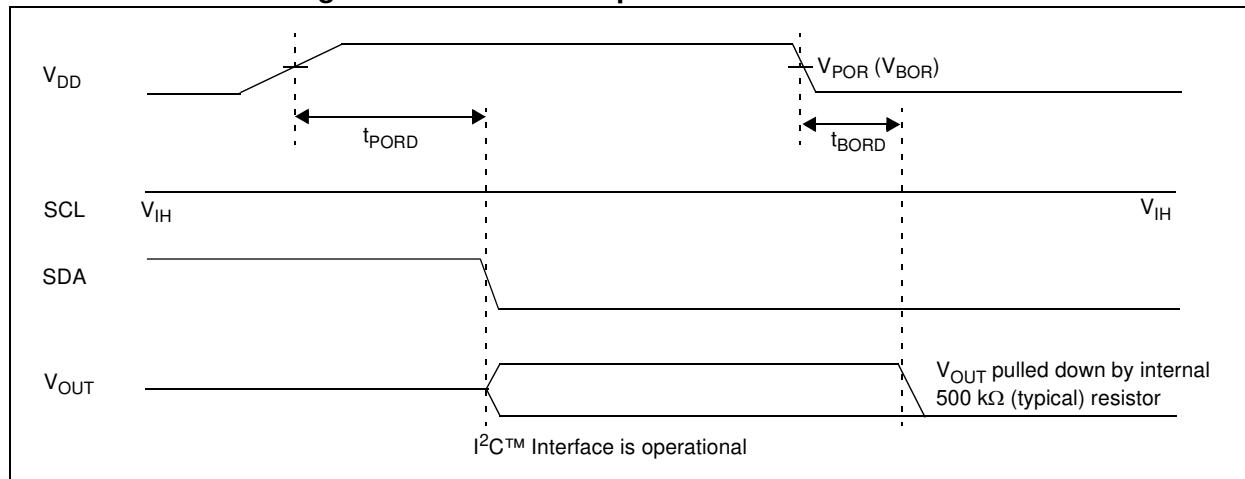
**4:** The power-up ramp rate affects on uploading the EEPROM contents to the DAC register. It measures the rise of  $V_{DD}$  over time.

**5:** This parameter is ensured by characterization, and not 100% tested.

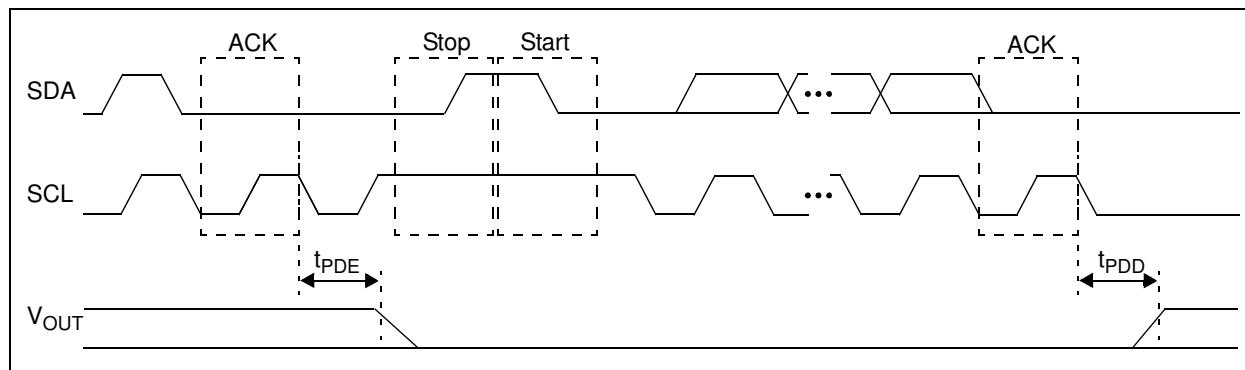
**6:** The PD1:PD0 = 10, and ‘11’ configurations should have the same current.

**7:**  $V_{DD} = V_{REF} = 5.5V$ .

## 1.1 I<sup>2</sup>C Mode Timing Waveforms and Requirements



**FIGURE 1-1:** Power-On and Brown-Out Reset Waveforms.

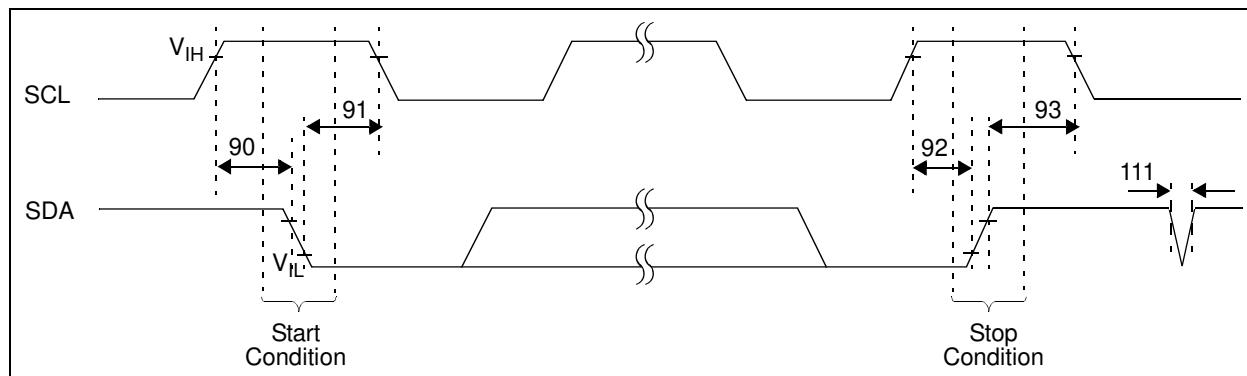


**FIGURE 1-2:** I<sup>2</sup>C Power-Down Command Timing.

**TABLE 1-1: RESET TIMING**

Timing Characteristics		Standard Operating Conditions (unless otherwise specified)				
Parameters	Sym	Min	Typ	Max	Units	Conditions
Power-Up Reset Delay	$t_{PORD}$	—	60	—	μs	Monitor ACK bit response to ensure device responds to command.
Brown-Out Reset Delay	$t_{BORD}$	—	1	—	μs	$V_{DD}$ transitions from $V_{DD(MIN)}$ → > $V_{POR}$ $V_{OUT}$ driven to $V_{OUT}$ disabled
Power-Down Disable Time Delay	$T_{PDD}$	—	2.5	—	μs	$V_{DD} = 5V$ PD1:PD0 → 00 (from '01', '10', or '11'), from falling edge SCL at end of ACK bit.
		—	5	—	μs	$V_{DD} = 3V$ PD1:PD0 → 00 (from '01', '10', or '11'), from falling edge SCL at end of ACK bit.
Power-Down Enable Time Delay	$T_{PDE}$	—	10.5	—	μs	PD1:PD0 → 01, '10', or '11' (from '00'), from falling edge SCL at end of ACK bit.

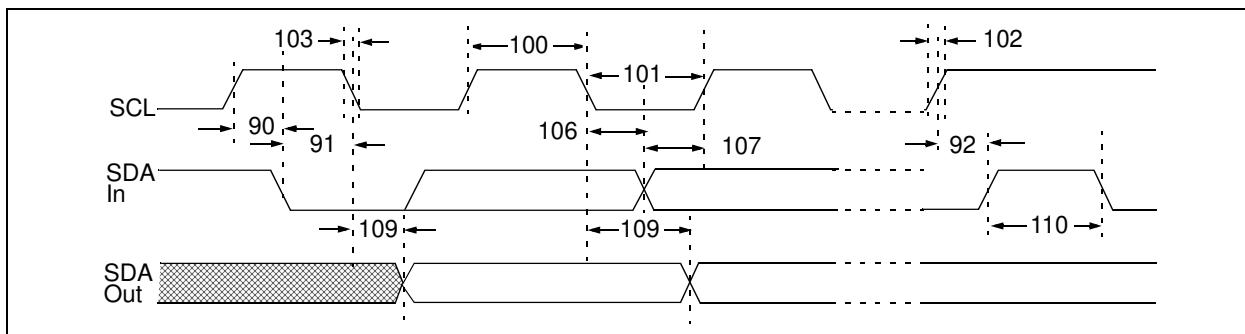
# MCP4706/4716/4726



**FIGURE 1-3:** I<sup>2</sup>C Bus Start/Stop Bits Timing Waveforms.

**TABLE 1-2: I<sup>2</sup>C BUS START/STOP BITS REQUIREMENTS**

I <sup>2</sup> C™ AC Characteristics			Standard Operating Conditions (unless otherwise specified)					
			Operating Temperature -40°C ≤ TA ≤ +125°C (Extended) Operating Voltage VDD range is described in <a href="#">Electrical Characteristics</a>					
Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions		
	$F_{SCL}$	SCL pin Frequency	Standard mode	0	100	kHz	$C_b = 400 \text{ pF}, 2.7V - 5.5V$	
			Fast mode	0	400	kHz	$C_b = 400 \text{ pF}, 2.7V - 5.5V$	
			High-Speed 1.7	0	1.7	MHz	$C_b = 400 \text{ pF}, 4.5V - 5.5V$	
			High-Speed 3.4	0	3.4	MHz	$C_b = 100 \text{ pF}, 4.5V - 5.5V$	
D102	$C_b$	Bus capacitive loading	100 kHz mode	—	400	pF		
			400 kHz mode	—	400	pF		
			1.7 MHz mode	—	400	pF		
			3.4 MHz mode	—	100	pF		
90	TSU:STA	Start condition Setup time	100 kHz mode	4700	—	ns	Only relevant for repeated Start condition	
			400 kHz mode	600	—	ns		
			1.7 MHz mode	160	—	ns		
			3.4 MHz mode	160	—	ns		
91	THD:STA	Start condition Hold time	100 kHz mode	4000	—	ns	After this period, the first clock pulse is generated	
			400 kHz mode	600	—	ns		
			1.7 MHz mode	160	—	ns		
			3.4 MHz mode	160	—	ns		
92	TSU:STO	Stop condition Setup time	100 kHz mode	4000	—	ns		
			400 kHz mode	600	—	ns		
			1.7 MHz mode	160	—	ns		
			3.4 MHz mode	160	—	ns		
93	THD:STO	Stop condition Hold time	100 kHz mode	4000	—	ns		
			400 kHz mode	600	—	ns		
			1.7 MHz mode	160	—	ns		
			3.4 MHz mode	160	—	ns		
94	$T_{HVCSU}$	HVC to SCL Setup time	25	—	uS	High Voltage Commands		
95	$T_{HVCHD}$	SCL to HVC Hold time	25	—	uS	High Voltage Commands		



**FIGURE 1-4:**  $I^2C$  Bus Data Timing.

**TABLE 1-3:  $I^2C$  BUS DATA REQUIREMENTS (SLAVE MODE)**

$I^2C$ ™ AC Characteristics			Standard Operating Conditions (unless otherwise specified)				
Param. No.	Sym	Characteristic		Min	Max	Units	Conditions
100	T <sub>HIGH</sub>	Clock high time	100 kHz mode	4000	—	ns	2.7V-5.5V
			400 kHz mode	600	—	ns	2.7V-5.5V
			1.7 MHz mode	120	—	ns	4.5V-5.5V
			3.4 MHz mode	60	—	ns	4.5V-5.5V
101	T <sub>LOW</sub>	Clock low time	100 kHz mode	4700	—	ns	2.7V-5.5V
			400 kHz mode	1300	—	ns	2.7V-5.5V
			1.7 MHz mode	320	—	ns	4.5V-5.5V
			3.4 MHz mode	160	—	ns	4.5V-5.5V

- Note 1:** As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.
- 2:** A Fast mode (400 kHz)  $I^2C$ ™ bus device can be used in a Standard mode (100 kHz)  $I^2C$  bus system, but the requirement  $t_{SU;DAT} \geq 250$  ns must then be met. This will automatically be the case if the device does not stretch the Low period of the SCL signal. If such a device does stretch the Low period of the SCL signal, it must output the next data bit to the SDA line.  
 $T_R \text{ max.} + t_{SU;DAT} = 1000 + 250 = 1250$  ns (according to the Standard mode  $I^2C$  bus specification) before the SCL line is released.
- 3:** The MCP47X6 device must provide a data hold time to bridge the undefined part between  $V_{IH}$  and  $V_{IL}$  of the falling edge of the SCL signal. This specification is not a part of the  $I^2C$  specification, but must be tested in order to ensure that the output data will meet the setup and hold specifications for the receiving device.
- 4:** Use  $C_b$  in pF for the calculations.
- 5:** Not Tested. This parameter ensured by characterization.
- 6:** A Master Transmitter must provide a delay to ensure that difference between SDA and SCL fall times do not unintentionally create a Start or Stop condition.  
If this parameter is too short, it can create an unintentional Start or Stop condition to other devices on the  $I^2C$  bus line. If this parameter is too long, the Data Input Setup ( $t_{SU;DAT}$ ) or Clock Low time ( $T_{LOW}$ ) can be affected.
- Data Input:** This parameter must be longer than  $t_{SP}$ .  
**Data Output:** This parameter is characterized, and tested indirectly by testing  $T_{AA}$  parameter.
- 7:** Ensured by the  $T_{AA}$  3.4 MHz specification test.
- 8:** The specification is not part of the  $I^2C$  specification.  $T_{AA} = T_{HD;DAT} + T_{FSDA}$  (or  $T_{RSDA}$ ).

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TABLE 1-3: I<sup>2</sup>C BUS DATA REQUIREMENTS (SLAVE MODE) (CONTINUED)

I <sup>2</sup> C™ AC Characteristics			Standard Operating Conditions (unless otherwise specified)				
Param. No.	Sym	Characteristic		Min	Max	Units	Conditions
102A <sup>(5)</sup>	T <sub>RSCL</sub>	SCL rise time	100 kHz mode	—	1000	ns	C <sub>b</sub> is specified to be from 10 to 400 pF (100 pF maximum for 3.4 MHz mode)
			400 kHz mode	20 + 0.1C <sub>b</sub>	300	ns	
			1.7 MHz mode	20	80	ns	
			1.7 MHz mode	20	160	ns	After a Repeated Start condition or an Acknowledge bit
			3.4 MHz mode	10	40	ns	
			3.4 MHz mode	10	80	ns	After a Repeated Start condition or an Acknowledge bit
102B <sup>(5)</sup>	T <sub>RSDA</sub>	SDA rise time	100 kHz mode	—	1000	ns	C <sub>b</sub> is specified to be from 10 to 400 pF (100 pF max for 3.4 MHz mode)
			400 kHz mode	20 + 0.1C <sub>b</sub>	300	ns	
			1.7 MHz mode	20	160	ns	
			3.4 MHz mode	10	80	ns	
103A <sup>(5)</sup>	T <sub>FSCL</sub>	SCL fall time	100 kHz mode	—	300	ns	C <sub>b</sub> is specified to be from 10 to 400 pF (100 pF max for 3.4 MHz mode)
			400 kHz mode	20 + 0.1C <sub>b</sub>	300	ns	
			1.7 MHz mode	20	80	ns	
			3.4 MHz mode	10	40	ns	
103B <sup>(5)</sup>	T <sub>FSDA</sub>	SDA fall time	100 kHz mode	—	300	ns	C <sub>b</sub> is specified to be from 10 to 400 pF (100 pF max for 3.4 MHz mode)
			400 kHz mode	20 + 0.1C <sub>b</sub> <sup>(4)</sup>	300	ns	
			1.7 MHz mode	20	160	ns	
			3.4 MHz mode	10	80	ns	

**Note 1:** As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.

**2:** A Fast mode (400 kHz) I<sup>2</sup>C™ bus device can be used in a Standard mode (100 kHz) I<sup>2</sup>C bus system, but the requirement t<sub>SU;DAT</sub> ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the Low period of the SCL signal. If such a device does stretch the Low period of the SCL signal, it must output the next data bit to the SDA line.

T<sub>R</sub> max.+t<sub>SU;DAT</sub> = 1000 + 250 = 1250 ns (according to the Standard mode I<sup>2</sup>C bus specification) before the SCL line is released.

**3:** The MCP47X6 device must provide a data hold time to bridge the undefined part between V<sub>IH</sub> and V<sub>IL</sub> of the falling edge of the SCL signal. This specification is not a part of the I<sup>2</sup>C specification, but must be tested in order to ensure that the output data will meet the setup and hold specifications for the receiving device.

**4:** Use C<sub>b</sub> in pF for the calculations.

**5:** Not Tested. This parameter ensured by characterization.

**6:** A Master Transmitter must provide a delay to ensure that difference between SDA and SCL fall times do not unintentionally create a Start or Stop condition.

If this parameter is too short, it can create an unintentional Start or Stop condition to other devices on the I<sup>2</sup>C bus line. If this parameter is too long, the Data Input Setup (t<sub>SU;DAT</sub>) or Clock Low time (t<sub>LOW</sub>) can be affected.

**Data Input:** This parameter must be longer than t<sub>SP</sub>.

**Data Output:** This parameter is characterized, and tested indirectly by testing T<sub>AA</sub> parameter.

**7:** Ensured by the T<sub>AA</sub> 3.4 MHz specification test.

**8:** The specification is not part of the I<sup>2</sup>C specification. T<sub>AA</sub> = T<sub>HD;DAT</sub> + T<sub>FSDA</sub> (or T<sub>RSDA</sub>).

**TABLE 1-3: I<sup>2</sup>C BUS DATA REQUIREMENTS (SLAVE MODE) (CONTINUED)**

I <sup>2</sup> C™ AC Characteristics			Standard Operating Conditions (unless otherwise specified)				
Param. No.	Sym	Characteristic	Min	Max	Units	Conditions	
106	T <sub>HD:DAT</sub>	Data input hold time	100 kHz mode	0	—	ns	2.7V-5.5V, Note 6
			400 kHz mode	0	—	ns	2.7V-5.5V, Note 6
			1.7 MHz mode	0	—	ns	4.5V-5.5V, Note 6
			3.4 MHz mode	0	—	ns	4.5V-5.5V, Note 6
107	T <sub>SU:DAT</sub>	Data input setup time	100 kHz mode	250	—	ns	Note 2
			400 kHz mode	100	—	ns	
			1.7 MHz mode	10	—	ns	
			3.4 MHz mode	10	—	ns	
109	T <sub>AA</sub>	Output valid from clock	100 kHz mode	—	3750	ns	Note 1, Note 8
			400 kHz mode	—	1200	ns	
			1.7 MHz mode	—	150	ns	C <sub>b</sub> = 100 pF, Note 1, Note 7, Note 8
			—	310	ns	C <sub>b</sub> = 400 pF, Note 1, Note 5, Note 8	
			3.4 MHz mode	—	150	ns	C <sub>b</sub> = 100 pF, Note 1, Note 8
110	T <sub>BUF</sub>	Bus free time	100 kHz mode	4700	—	ns	Time the bus must be free before a new transmission can start
			400 kHz mode	1300	—	ns	
			1.7 MHz mode	N/A	—	ns	
			3.4 MHz mode	N/A	—	ns	

**Note 1:** As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.

**2:** A Fast mode (400 kHz) I<sup>2</sup>C™ bus device can be used in a Standard mode (100 kHz) I<sup>2</sup>C bus system, but the requirement  $t_{SU:DAT} \geq 250$  ns must then be met. This will automatically be the case if the device does not stretch the Low period of the SCL signal. If such a device does stretch the Low period of the SCL signal, it must output the next data bit to the SDA line.

$T_R \max + t_{SU:DAT} = 1000 + 250 = 1250$  ns (according to the Standard mode I<sup>2</sup>C bus specification) before the SCL line is released.

**3:** The MCP47X6 device must provide a data hold time to bridge the undefined part between V<sub>IH</sub> and V<sub>IL</sub> of the falling edge of the SCL signal. This specification is not a part of the I<sup>2</sup>C specification, but must be tested in order to ensure that the output data will meet the setup and hold specifications for the receiving device.

**4:** Use C<sub>b</sub> in pF for the calculations.

**5:** Not Tested. This parameter ensured by characterization.

**6:** A Master Transmitter must provide a delay to ensure that difference between SDA and SCL fall times do not unintentionally create a Start or Stop condition.

If this parameter is too short, it can create an unintentional Start or Stop condition to other devices on the I<sup>2</sup>C bus line. If this parameter is too long, the Data Input Setup (T<sub>SU:DAT</sub>) or Clock Low time (T<sub>LOW</sub>) can be affected.

**Data Input:** This parameter must be longer than t<sub>SP</sub>.

**Data Output:** This parameter is characterized, and tested indirectly by testing T<sub>AA</sub> parameter.

**7:** Ensured by the T<sub>AA</sub> 3.4 MHz specification test.

**8:** The specification is not part of the I<sup>2</sup>C specification. T<sub>AA</sub> = T<sub>HD:DAT</sub> + T<sub>FSDA</sub> (or T<sub>RSDA</sub>).

# MCP4706/4716/4726

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**TABLE 1-3: I<sup>2</sup>C BUS DATA REQUIREMENTS (SLAVE MODE) (CONTINUED)**

I <sup>2</sup> C™ AC Characteristics			Standard Operating Conditions (unless otherwise specified)				
Param. No.	Sym	Characteristic	Min	Max	Units	Conditions	
111	T <sub>SP</sub>	Input filter spike suppression (SDA and SCL)	100 kHz mode	—	50	ns	NXP Spec states N/A
			400 kHz mode	—	50	ns	
			1.7 MHz mode	—	10	ns	Spike suppression
			3.4 MHz mode	—	10	ns	Spike suppression

- Note 1:** As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.
- 2:** A Fast mode (400 kHz) I<sup>2</sup>C™ bus device can be used in a Standard mode (100 kHz) I<sup>2</sup>C bus system, but the requirement  $t_{SU:DAT} \geq 250$  ns must then be met. This will automatically be the case if the device does not stretch the Low period of the SCL signal. If such a device does stretch the Low period of the SCL signal, it must output the next data bit to the SDA line.  
 $T_R \max + t_{SU:DAT} = 1000 + 250 = 1250$  ns (according to the Standard mode I<sup>2</sup>C bus specification) before the SCL line is released.
- 3:** The MCP47X6 device must provide a data hold time to bridge the undefined part between V<sub>IH</sub> and V<sub>IL</sub> of the falling edge of the SCL signal. This specification is not a part of the I<sup>2</sup>C specification, but must be tested in order to ensure that the output data will meet the setup and hold specifications for the receiving device.
- 4:** Use C<sub>b</sub> in pF for the calculations.
- 5:** Not Tested. This parameter ensured by characterization.
- 6:** A Master Transmitter must provide a delay to ensure that difference between SDA and SCL fall times do not unintentionally create a Start or Stop condition.  
If this parameter is too short, it can create an unintentional Start or Stop condition to other devices on the I<sup>2</sup>C bus line. If this parameter is too long, the Data Input Setup ( $t_{SU:DAT}$ ) or Clock Low time ( $T_{LOW}$ ) can be affected.
- Data Input:** This parameter must be longer than t<sub>SP</sub>.
- Data Output:** This parameter is characterized, and tested indirectly by testing T<sub>AA</sub> parameter.
- 7:** Ensured by the T<sub>AA</sub> 3.4 MHz specification test.
- 8:** The specification is not part of the I<sup>2</sup>C specification.  $T_{AA} = T_{HD:DAT} + T_{FSDA}$  (or T<sub>RSDA</sub>).

## TEMPERATURE CHARACTERISTICS

**Electrical Specifications:** Unless otherwise indicated,  $V_{DD} = +2.7V$  to  $+5.5V$ ,  $V_{SS} = GND$ .

Parameters	Symbol	Min	Typical	Max	Units	Conditions
<b>Temperature Ranges</b>						
Specified Temperature Range	$T_A$	-40	—	+125	°C	
Operating Temperature Range	$T_A$	-40	—	+125	°C	<b>Note 1</b>
Storage Temperature Range	$T_A$	-65	—	+150	°C	
<b>Thermal Package Resistances</b>						
Thermal Resistance, 6L-SOT-23	$\theta_{JA}$	—	190	—	°C/W	
Thermal Resistance, 6L-DFN (2 x 2)	$\theta_{JA}$	—	91	—	°C/W	

**Note 1:** The MCP47X6 devices operate over this extended temperature range, but with reduced performance. Operation in this range must not cause  $T_J$  to exceed the Maximum Junction Temperature of +150°C.

# **MCP4706/4716/4726**

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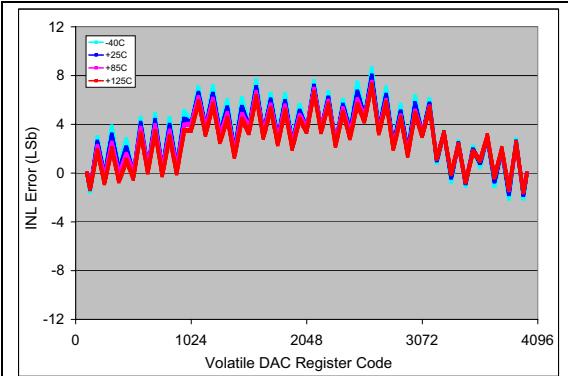
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## **NOTES:**

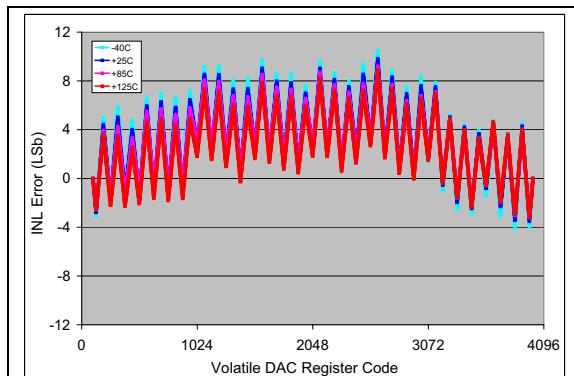
## 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

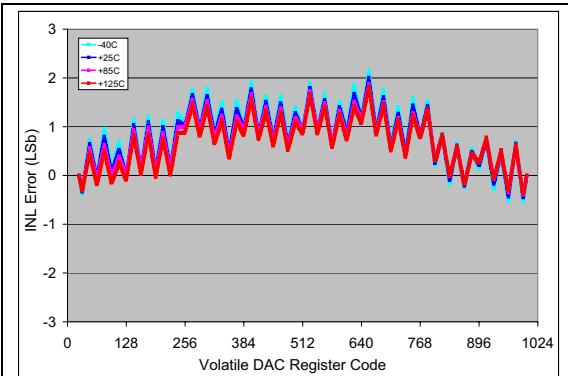
**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain =  $\times 1$ ,  $R_L = 5\text{ k}\Omega$ ,  $C_L = 100\text{ pF}$ .



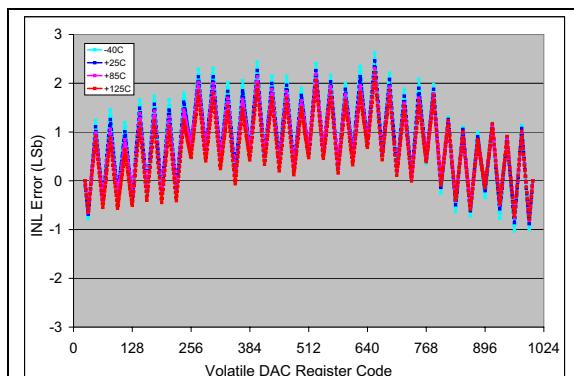
**FIGURE 2-1:** INL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).  
 $V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



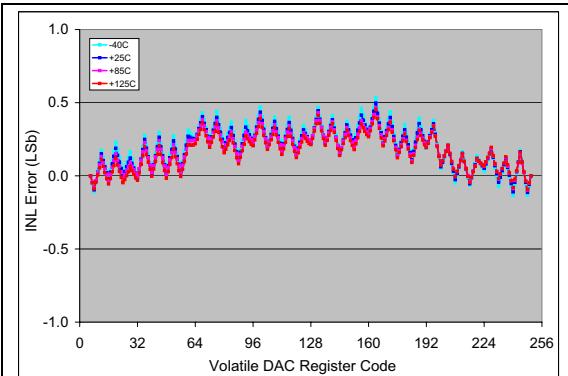
**FIGURE 2-4:** INL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).  
 $V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



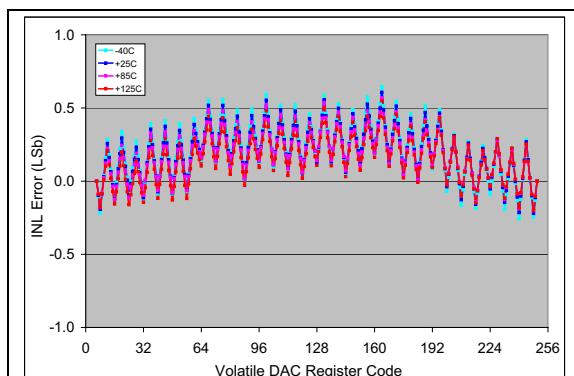
**FIGURE 2-2:** INL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).  
 $V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



**FIGURE 2-5:** INL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).  
 $V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



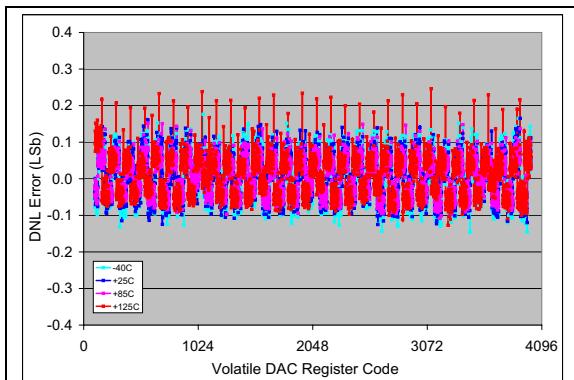
**FIGURE 2-3:** INL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).  
 $V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



**FIGURE 2-6:** INL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).  
 $V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .

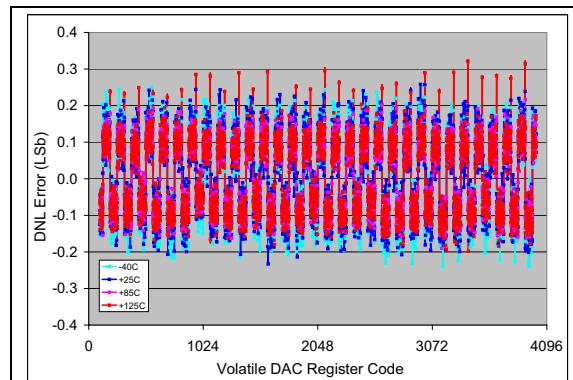
# MCP4706/4716/4726

Note: Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain = x1,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



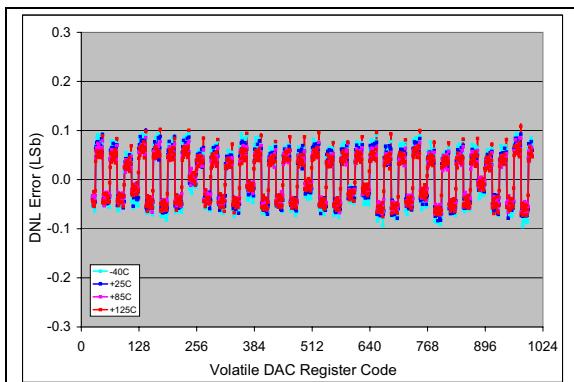
**FIGURE 2-7:** DNL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



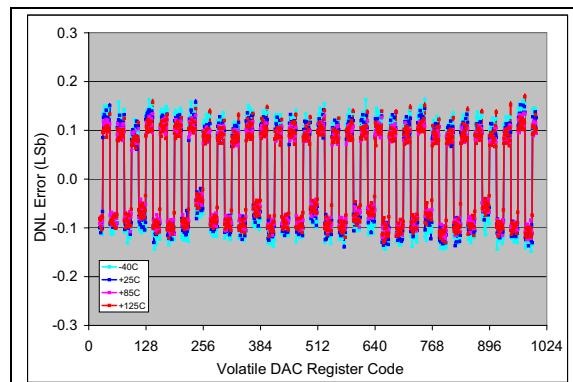
**FIGURE 2-10:** DNL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



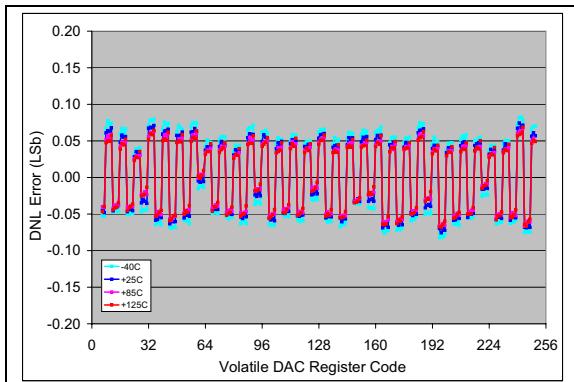
**FIGURE 2-8:** DNL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



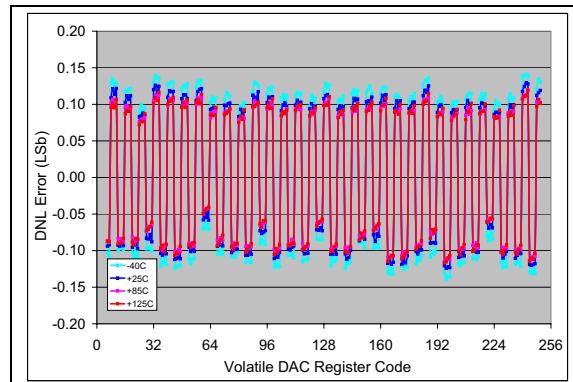
**FIGURE 2-11:** DNL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .



**FIGURE 2-9:** DNL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .

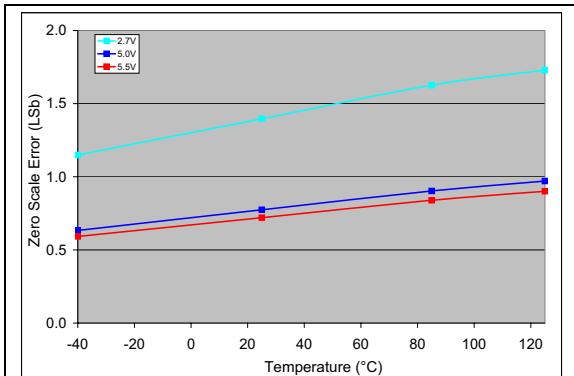


**FIGURE 2-12:** DNL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

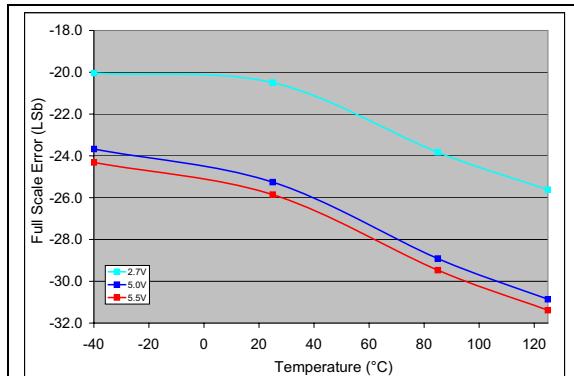
$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 0:0$ .

# MCP4706/4716/4726

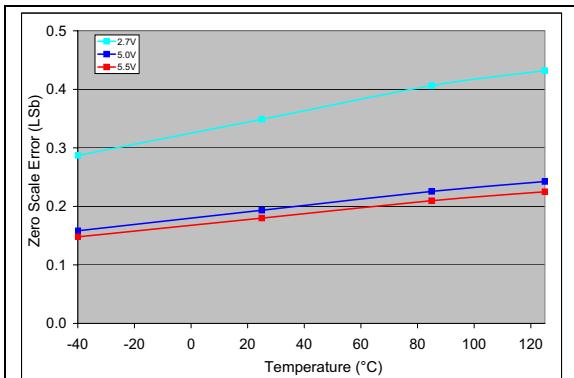
**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain =  $\times 1$ ,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



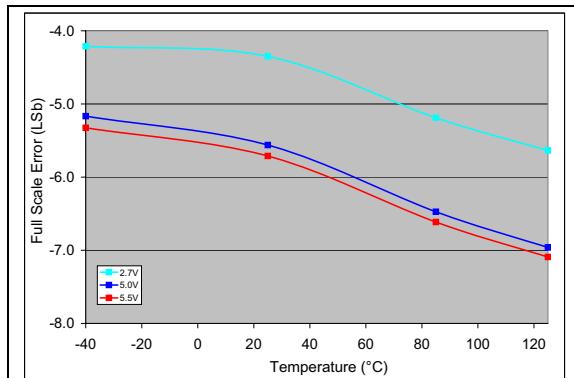
**FIGURE 2-13:** Zero-Scale Error (ZSE) vs.  $V_{DD}$  and Temperature (**MCP4726**).  
 $V_{REF1}:V_{REF0} = 0.0$ .



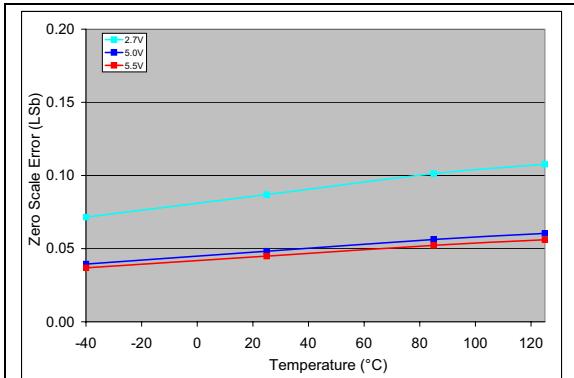
**FIGURE 2-16:** Full-Scale Error (FSE) vs.  $V_{DD}$  and Temperature (**MCP4726**).  
 $V_{REF1}:V_{REF0} = 0.0$ .



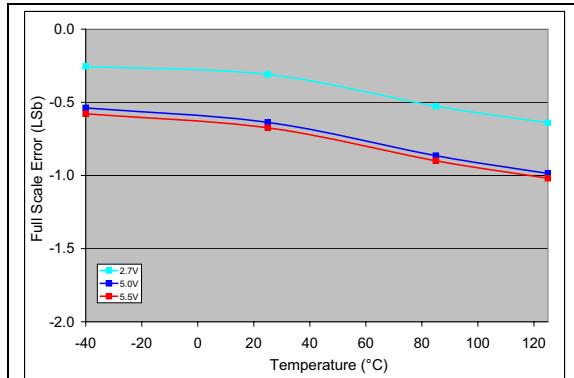
**FIGURE 2-14:** Zero-Scale Error (ZSE) vs.  $V_{DD}$  and Temperature (**MCP4716**).  
 $V_{REF1}:V_{REF0} = 0.0$ .



**FIGURE 2-17:** Full-Scale Error (FSE) vs.  $V_{DD}$  and Temperature (**MCP4716**).  
 $V_{REF1}:V_{REF0} = 0.0$ .



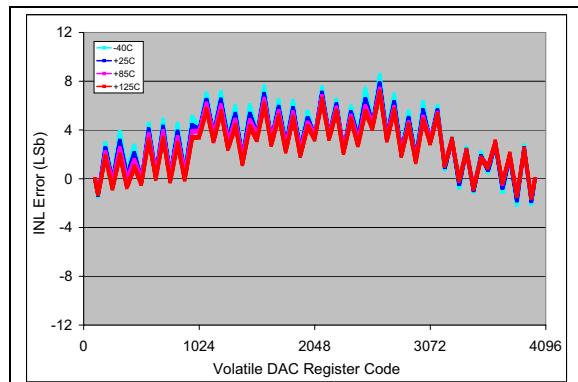
**FIGURE 2-15:** Zero-Scale Error (ZSE) vs.  $V_{DD}$  and Temperature (**MCP4706**).  
 $V_{REF1}:V_{REF0} = 0.0$ .



**FIGURE 2-18:** Full-Scale Error (FSE) vs.  $V_{DD}$  and Temperature (**MCP4706**).  
 $V_{REF1}:V_{REF0} = 0.0$ .

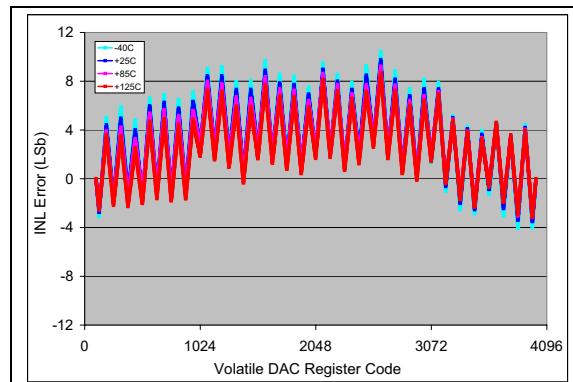
# MCP4706/4716/4726

**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain = x1,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



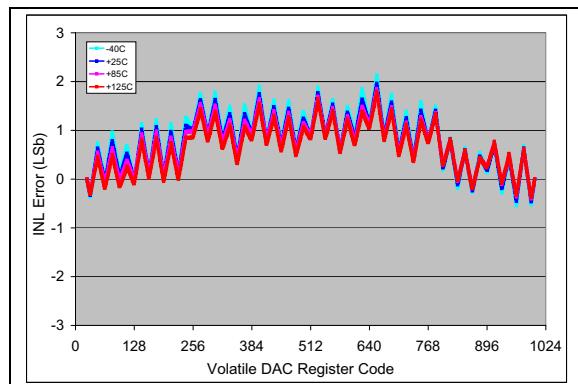
**FIGURE 2-19:** INL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



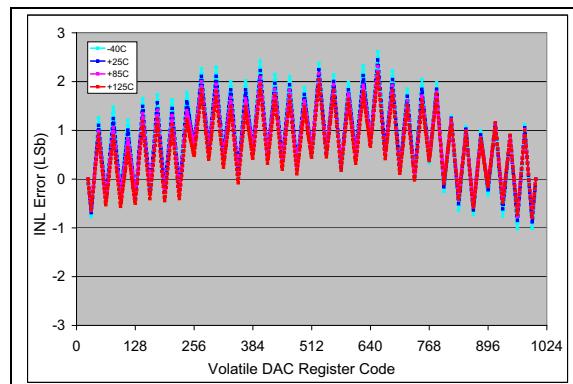
**FIGURE 2-22:** INL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



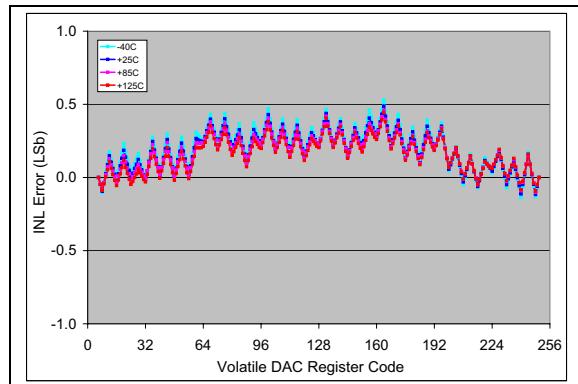
**FIGURE 2-20:** INL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



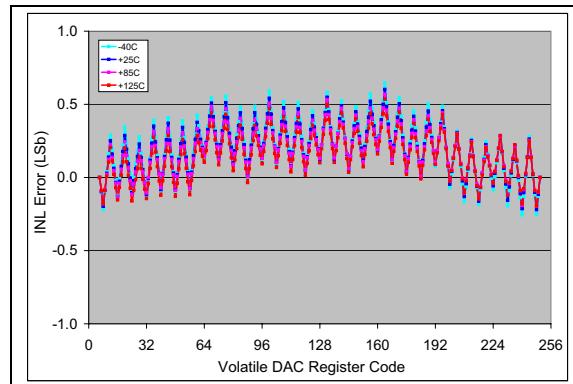
**FIGURE 2-23:** INL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



**FIGURE 2-21:** INL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

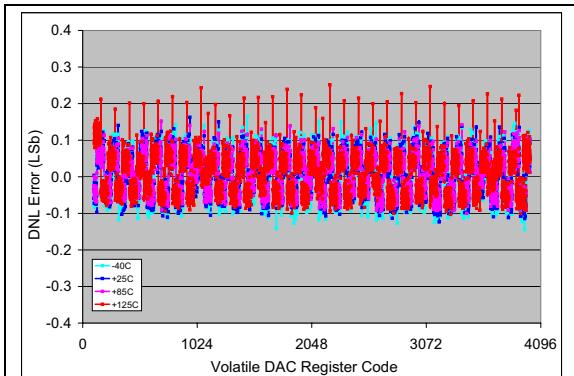


**FIGURE 2-24:** INL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

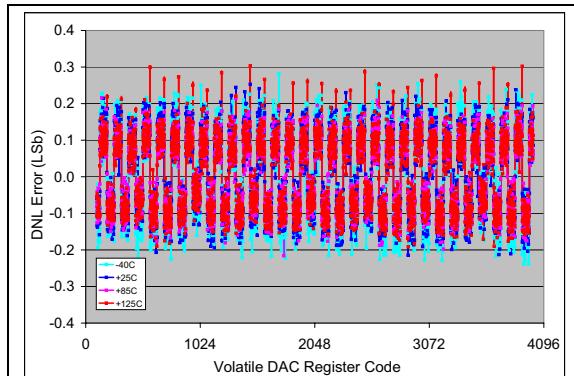
# MCP4706/4716/4726

**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL} = \text{Internal}$ , Gain = x1,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



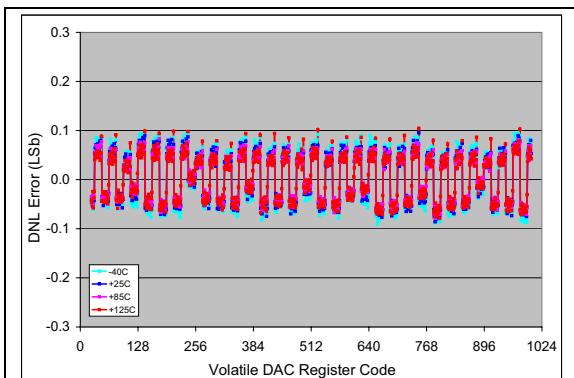
**FIGURE 2-25:** DNL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



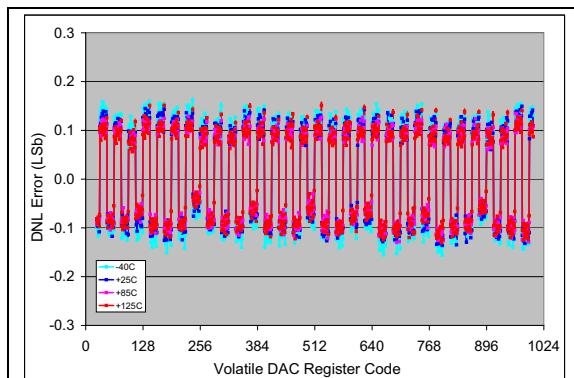
**FIGURE 2-28:** DNL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



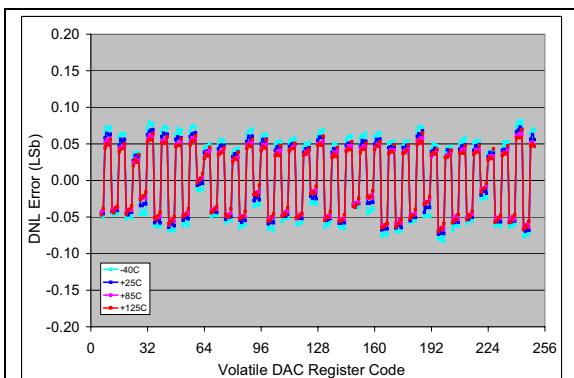
**FIGURE 2-26:** DNL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



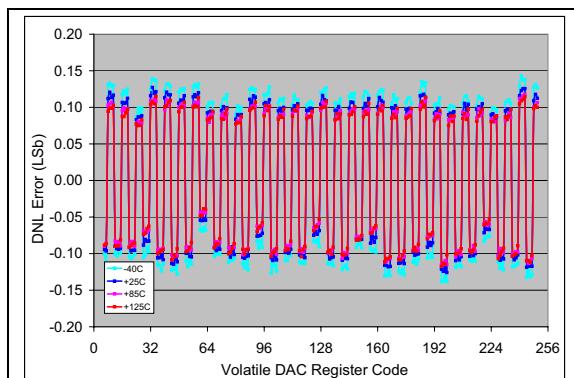
**FIGURE 2-29:** DNL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



**FIGURE 2-27:** DNL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

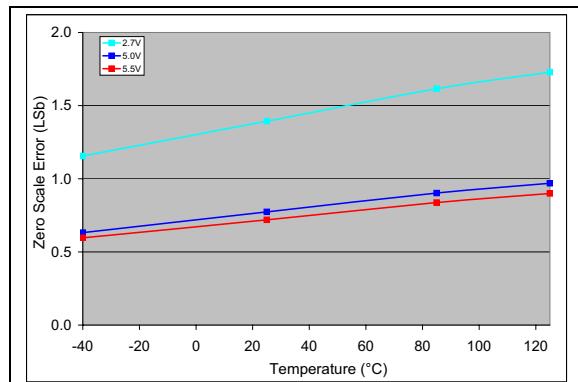


**FIGURE 2-30:** DNL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

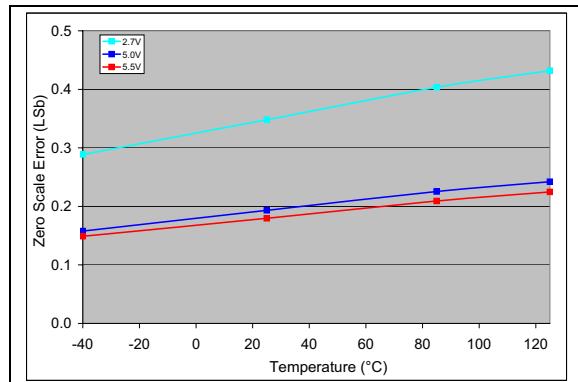
# MCP4706/4716/4726

**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain = x1,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



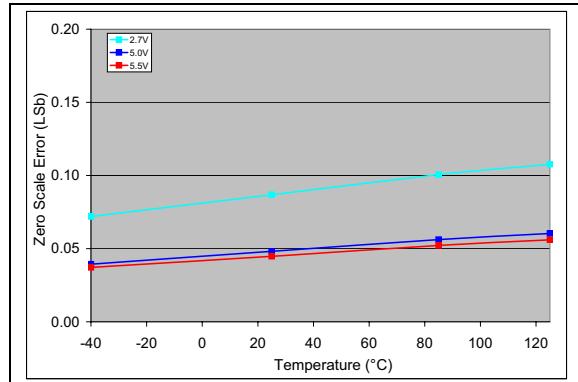
**FIGURE 2-31:** Zero-Scale Error (ZSE) vs. Temperature (**MCP4726**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



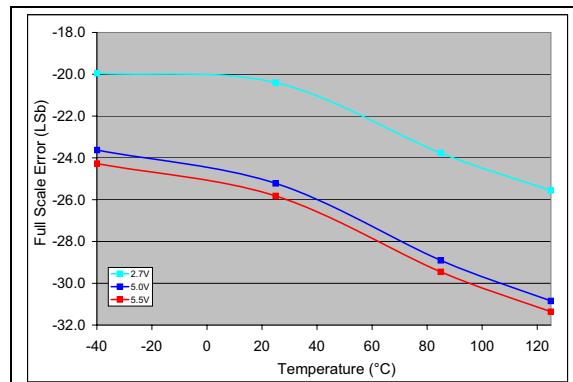
**FIGURE 2-32:** Zero-Scale Error (ZSE) vs. Temperature (**MCP4716**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



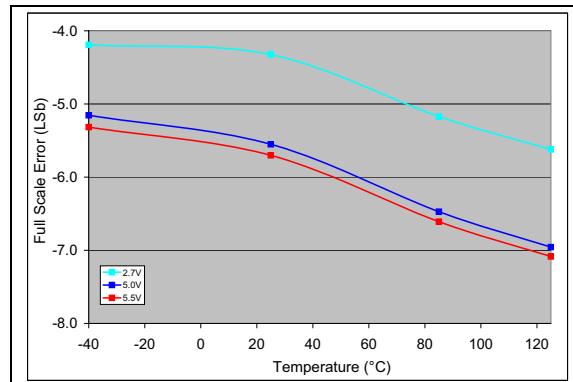
**FIGURE 2-33:** Zero-Scale Error (ZSE) vs. Temperature (**MCP4706**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



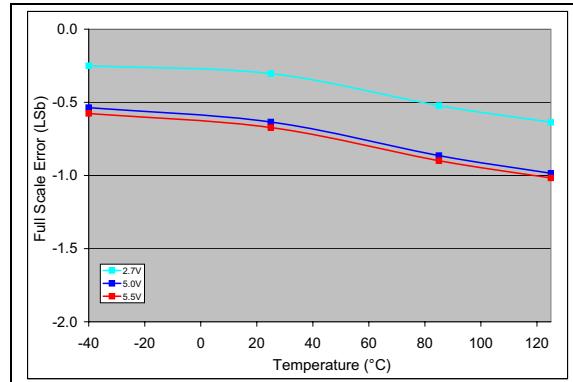
**FIGURE 2-34:** Full-Scale Error (FSE) vs. Temperature (**MCP4726**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



**FIGURE 2-35:** Full-Scale Error (FSE) vs. Temperature (**MCP4716**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

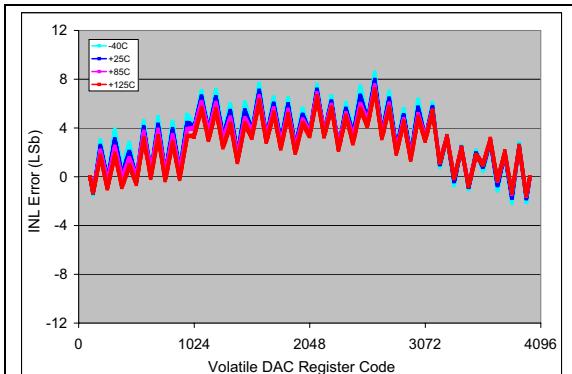


**FIGURE 2-36:** Full-Scale Error (FSE) vs. Temperature (**MCP4706**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 10$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

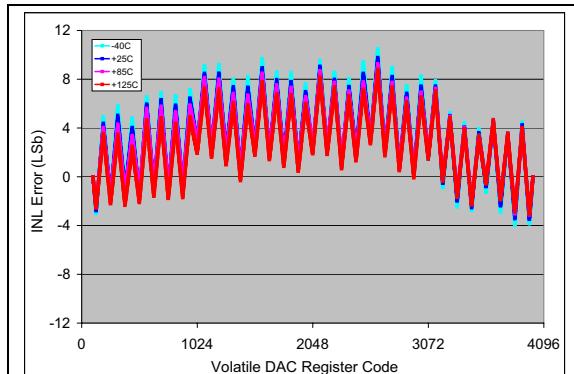
# MCP4706/4716/4726

**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL} = \text{Internal}$ , Gain =  $x1$ ,  $R_L = 5\text{ k}\Omega$ ,  $C_L = 100\text{ pF}$ .



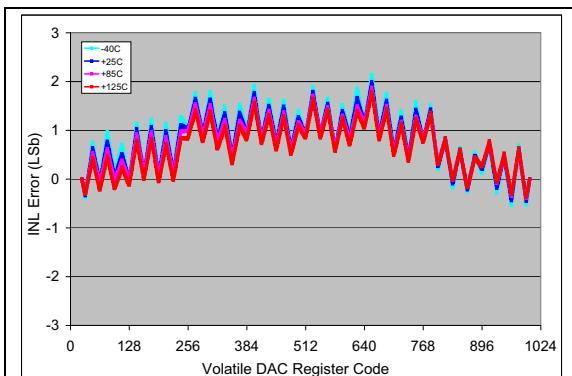
**FIGURE 2-37:** INL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



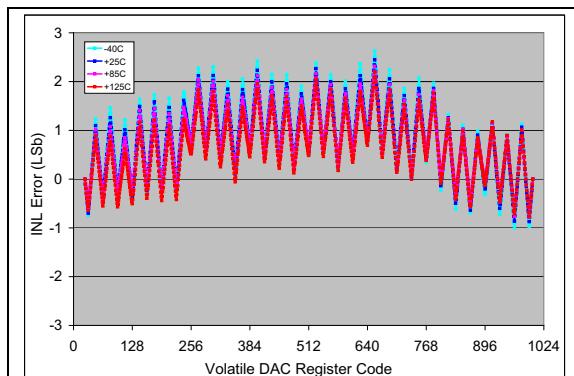
**FIGURE 2-40:** INL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



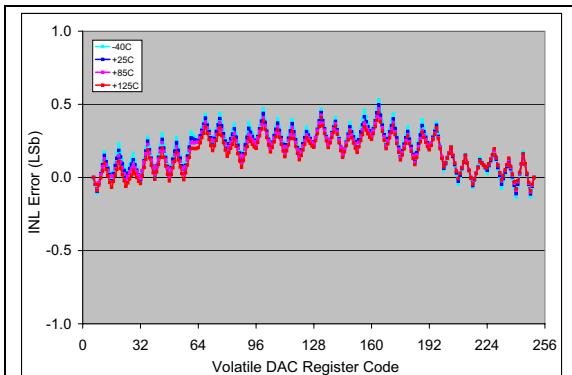
**FIGURE 2-38:** INL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



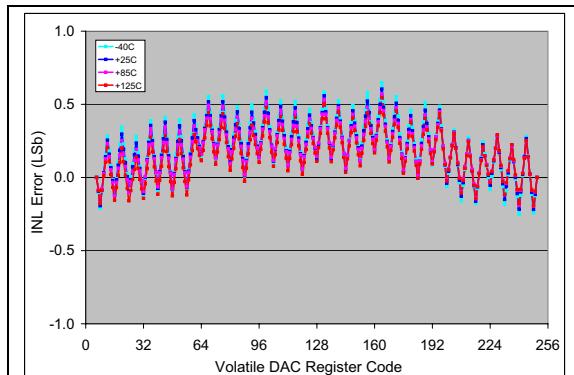
**FIGURE 2-41:** INL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



**FIGURE 2-39:** INL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

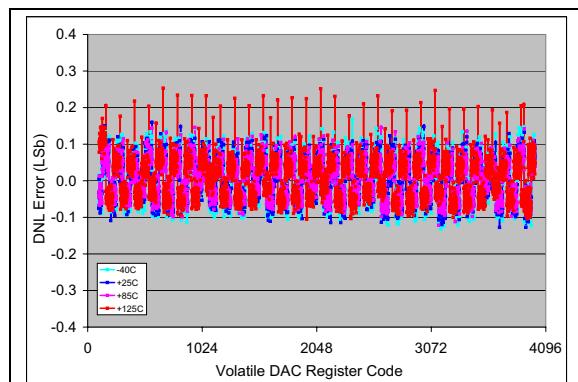


**FIGURE 2-42:** INL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

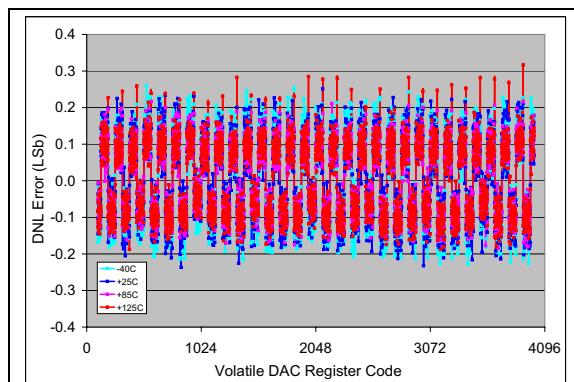
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**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain = x1,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



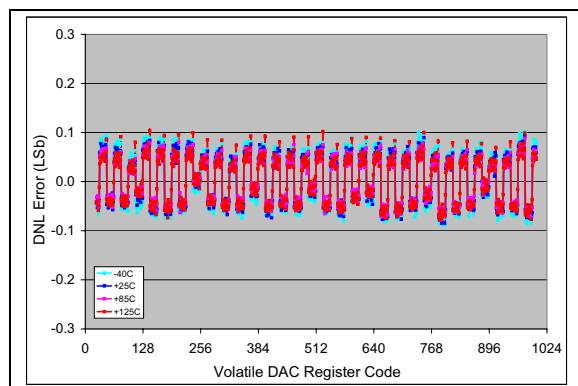
**FIGURE 2-43:** DNL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



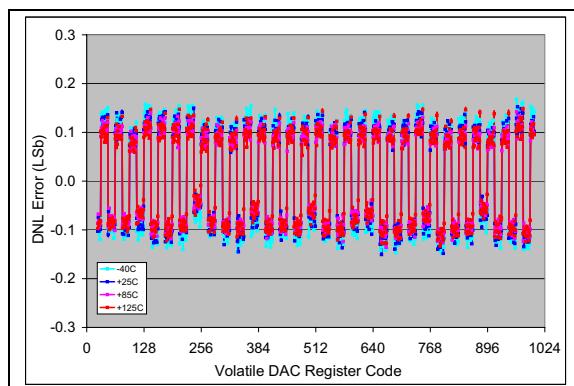
**FIGURE 2-46:** DNL vs. Code (code = 100 to 4000) and Temperature (**MCP4726**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



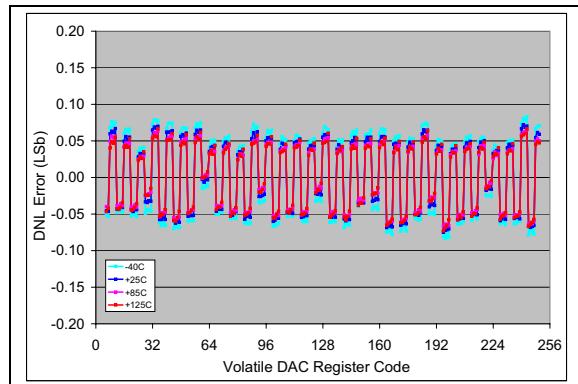
**FIGURE 2-44:** DNL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



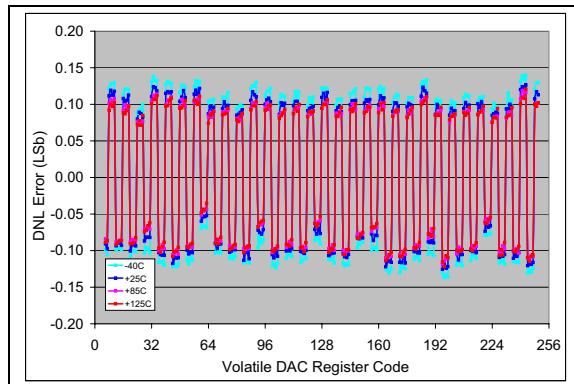
**FIGURE 2-47:** DNL vs. Code (code = 25 to 1000) and Temperature (**MCP4716**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



**FIGURE 2-45:** DNL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

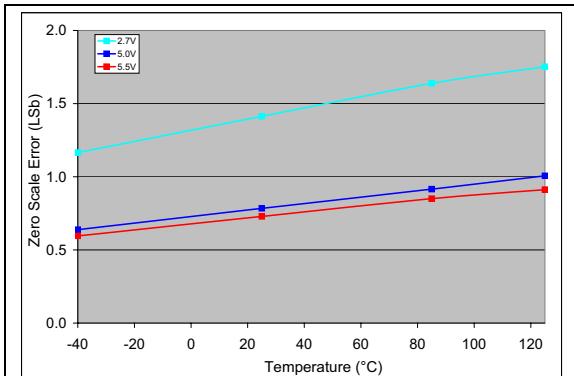


**FIGURE 2-48:** DNL vs. Code (code = 6 to 250) and Temperature (**MCP4706**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

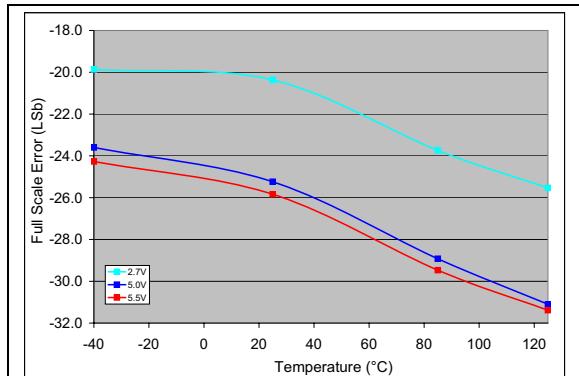
# MCP4706/4716/4726

**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain =  $x1$ ,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



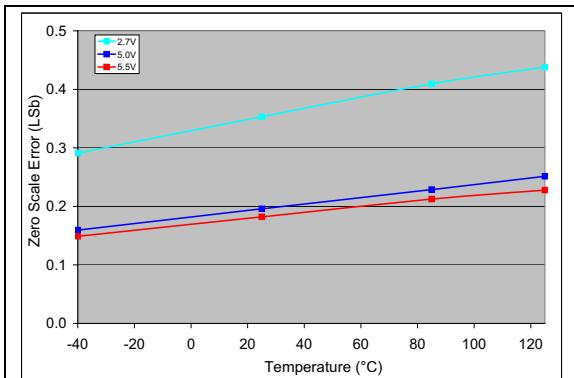
**FIGURE 2-49:** Zero-Scale Error (ZSE) vs. Temperature (**MCP4726**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



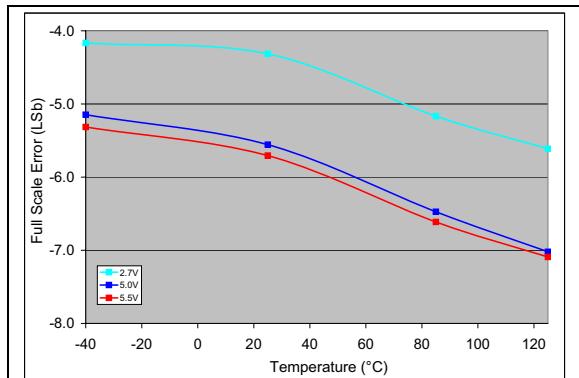
**FIGURE 2-52:** Full-Scale Error (FSE) vs. Temperature (**MCP4726**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



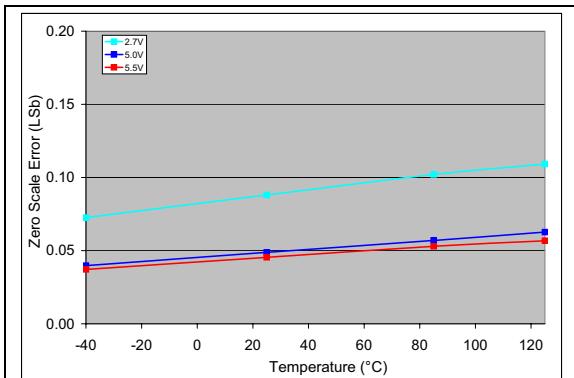
**FIGURE 2-50:** Zero-Scale Error (ZSE) vs. Temperature (**MCP4716**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



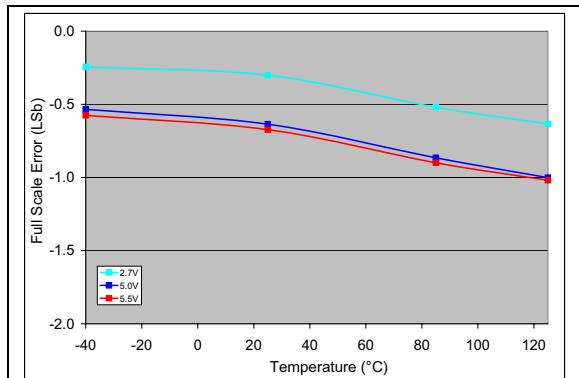
**FIGURE 2-53:** Full-Scale Error (FSE) vs. Temperature (**MCP4716**).

$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .



**FIGURE 2-51:** Zero-Scale Error (ZSE) vs. Temperature (**MCP4706**).

$V_{DD} = 5\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

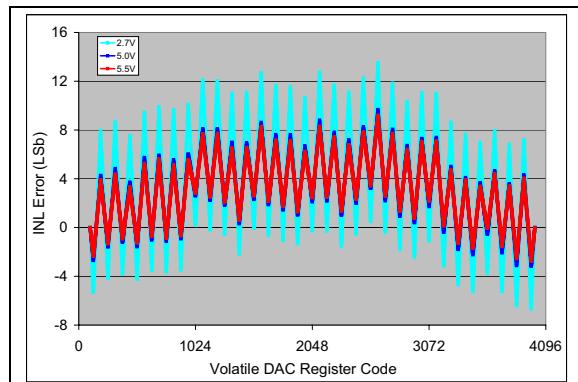


**FIGURE 2-54:** Full-Scale Error (FSE) vs. Temperature (**MCP4706**).

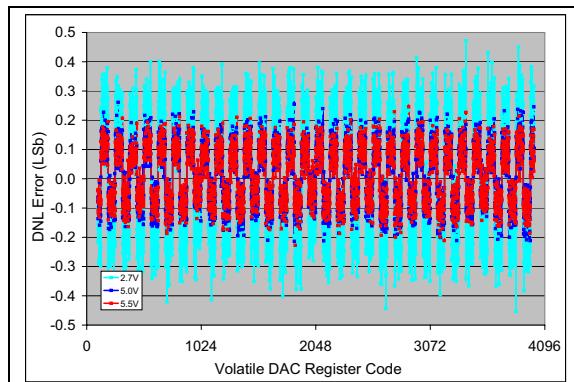
$V_{DD} = 2.7\text{V}$ ,  $V_{REF1}:V_{REF0} = 11$ ,  $G = 0$ ,  
 $V_{REF} = V_{DD}$ .

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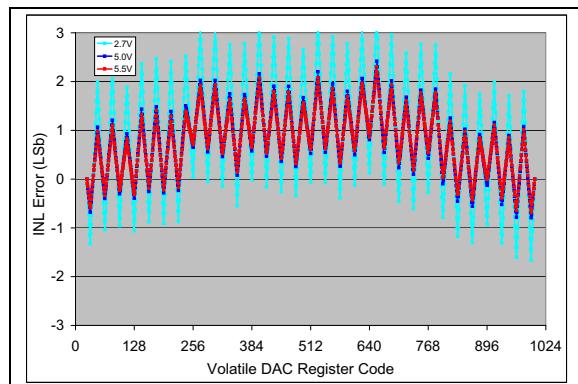
**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain = x1,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



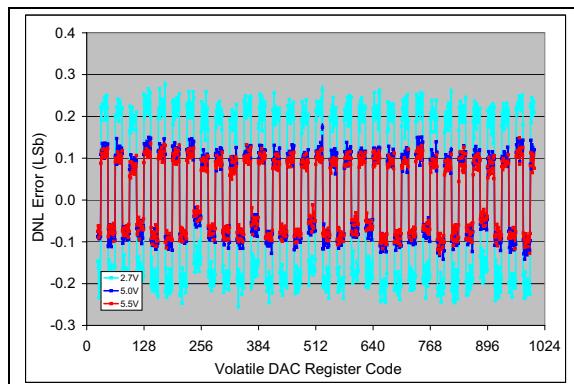
**FIGURE 2-55:** INL vs. Code (code = 100 to 4000) and  $V_{DD}$  (2.7V, 5V, 5.5V) (MCP4726).  
 $V_{REF1}:V_{REF0} = 10$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



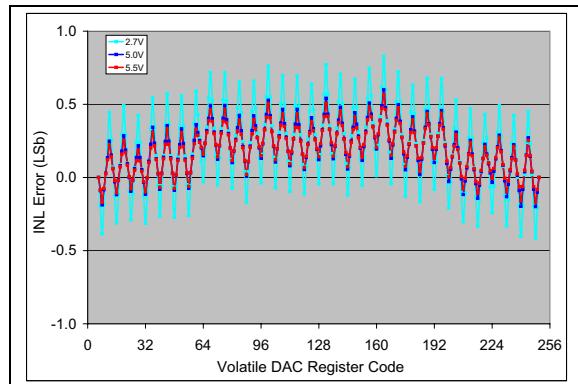
**FIGURE 2-58:** DNL vs. Code (code = 100 to 4000) and  $V_{DD}$  (2.7V, 5V, 5.5V) (MCP4726).  
 $V_{REF1}:V_{REF0} = 10$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



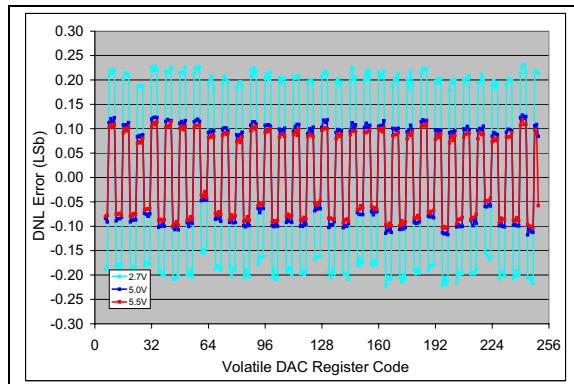
**FIGURE 2-56:** INL vs. Code (code = 25 to 1000) and  $V_{DD}$  (2.7V, 5V, 5.5V) (MCP4716).  
 $V_{REF1}:V_{REF0} = 10$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



**FIGURE 2-59:** DNL vs. Code (code = 25 to 1000) and  $V_{DD}$  (2.7V, 5V, 5.5V) (MCP4716).  
 $V_{REF1}:V_{REF0} = 10$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



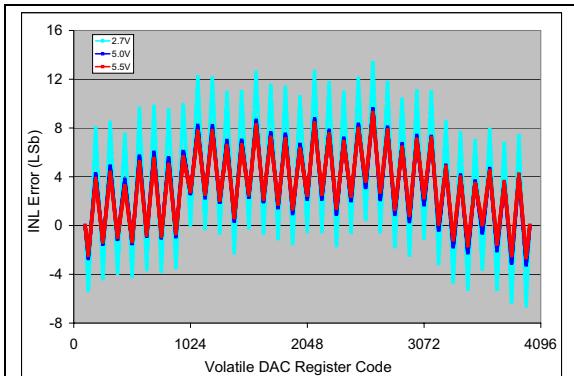
**FIGURE 2-57:** INL vs. Code (code = 6 to 250) and  $V_{DD}$  (2.7V, 5V, 5.5V) (MCP4706).  
 $V_{REF1}:V_{REF0} = 10$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



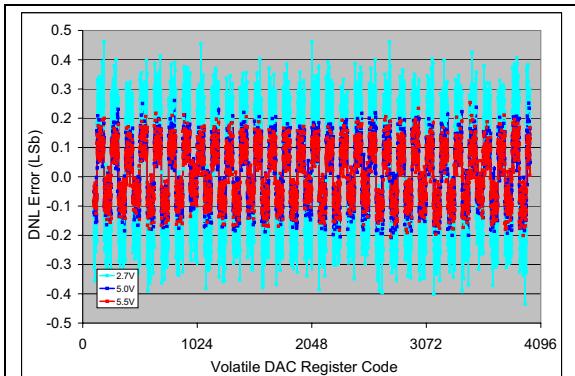
**FIGURE 2-60:** DNL vs. Code (code = 6 to 250) and  $V_{DD}$  (2.7V, 5V, 5.5V) (MCP4706).  
 $V_{REF1}:V_{REF0} = 10$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .

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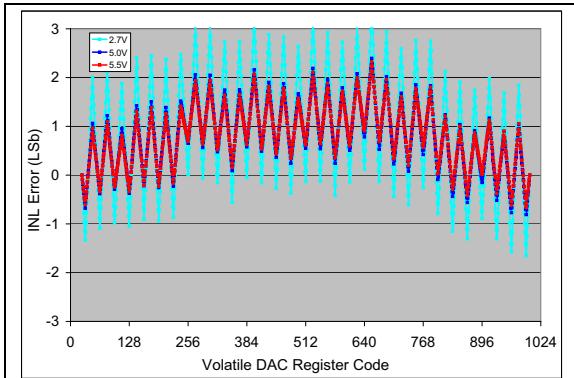
**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = 5\text{V}$ ,  $V_{SS} = 0\text{V}$ ,  $V_{RL}$  = Internal, Gain =  $x1$ ,  $R_L = 5\text{k}\Omega$ ,  $C_L = 100\text{ pF}$ .



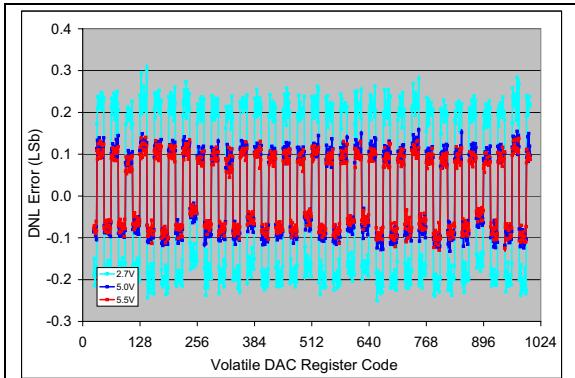
**FIGURE 2-61:** INL vs. Code (code = 100 to 4000) and  $V_{DD}$  (2.7V, 5V, 5.5V) (**MCP4726**).  
 $V_{REF1}:V_{REF0} = 11$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



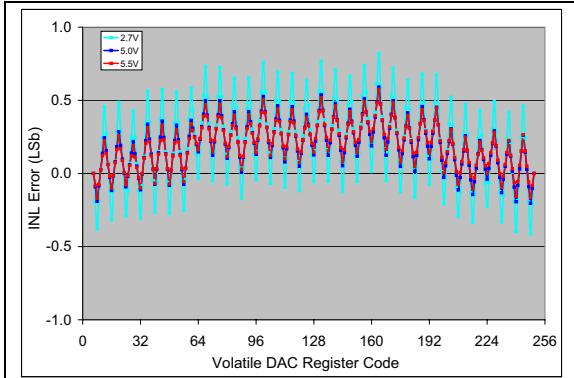
**FIGURE 2-64:** DNL vs. Code (code = 100 to 4000) and  $V_{DD}$  (2.7V, 5V, 5.5V) (**MCP4726**).  
 $V_{REF1}:V_{REF0} = 11$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



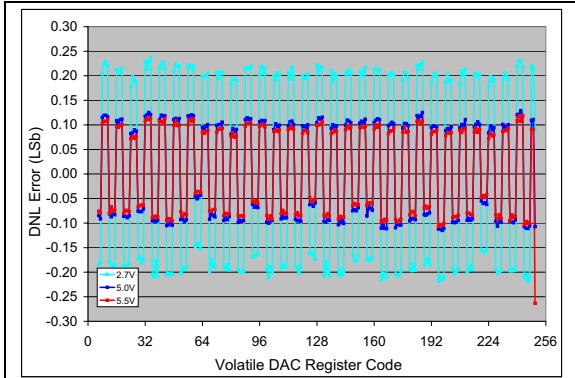
**FIGURE 2-62:** INL vs. Code (code = 25 to 1000) and  $V_{DD}$  (2.7V, 5V, 5.5V) (**MCP4716**).  
 $V_{REF1}:V_{REF0} = 11$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



**FIGURE 2-65:** DNL vs. Code (code = 25 to 1000) and  $V_{DD}$  (2.7V, 5V, 5.5V) (**MCP4716**).  
 $V_{REF1}:V_{REF0} = 11$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



**FIGURE 2-63:** INL vs. Code (code = 6 to 250) and  $V_{DD}$  (2.7V, 5V, 5.5V) (**MCP4706**).  
 $V_{REF1}:V_{REF0} = 11$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .



**FIGURE 2-66:** DNL vs. Code (code = 6 to 250) and  $V_{DD}$  (2.7V, 5V, 5.5V) (**MCP4706**).  
 $V_{REF1}:V_{REF0} = 11$ ,  $G = 1$ ,  $V_{REF} = V_{DD}/2$ ,  
Temp =  $+25^\circ\text{C}$ .